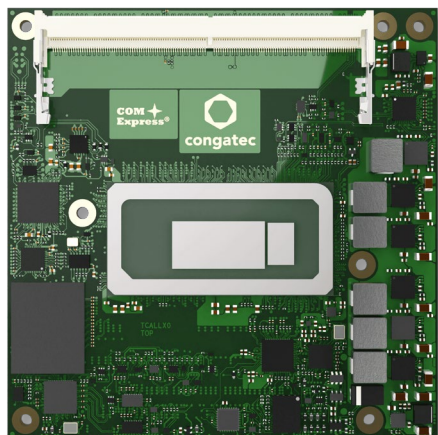


12th Gen Intel® Core™ Embedded mobile Processors

conga-TC670

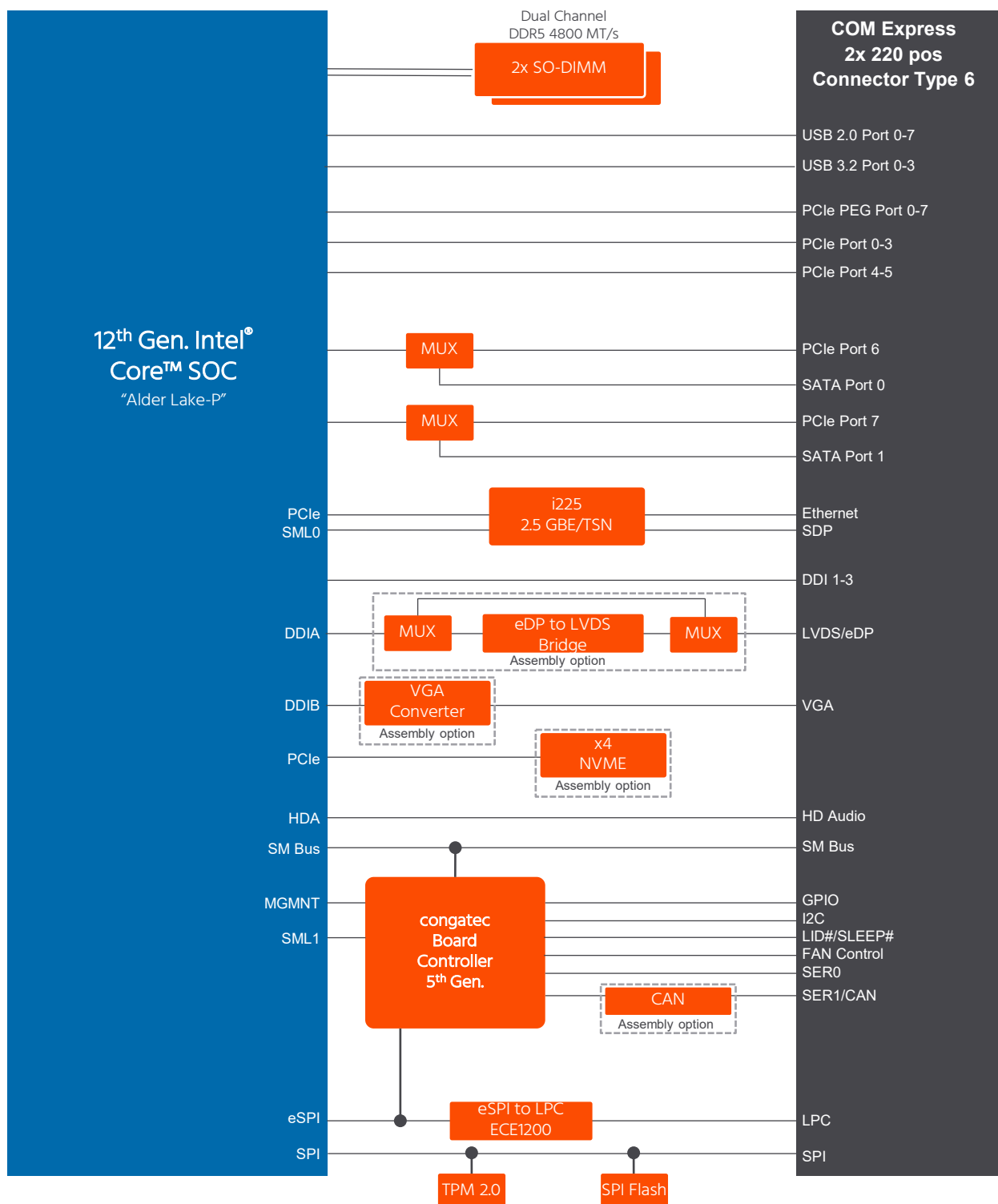


COM Express®

- Intel® hybrid design combines Performance-cores with Efficient-cores
- Up to Intel® Iris® Xe Graphics architecture with up to 96 EUs
- PCI Express Gen 4 | USB 3.2
- AI Acceleration with Intel® Deep Learning Boost (VNNI)
- Embedded Use Condition SKUs

Form factor	COM Express® Compact Type 6 connector pinout						
CPUs	CPU	TDP Target	Cores count (P+E)	Processor Threads	P-cores Freq. GHz	E-cores Freq. GHz	Gfx Execution Units
	i7-12800HE	45W	14 (6+8)	20	2.4 / 4.6	1.8 / 3.5	96
	i5-12600HE	45W	12 (4+8)	16	2.5 / 4.5	1.8 / 3.3	80
	i3-12300HE	45W	8 (4+4)	12	1.9 / 4.3	1.5 / 3.3	48
DRAM	2 SO-DIMM sockets for DDR5 memory modules up to 32 GByte each (max. 64 GByte system capacity) up to 4800 MT/s						
Mass Storage	NVMe x4 SSD (optional)						
Graphics	Intel® UHD Graphics or Intel® Iris® Xe Graphics architecture up to 96 EUs						
Display	3x DDI (up to 5K support) LVDS (optional eDP) VGA (optional)						
Ethernet	2.5 GbE TSN Ethernet (vial Intel® i225 LM)						
I/O Interfaces	8 PCIe Gen4 PEG up to 8 PCIe Gen3 8x USB (up to 4x USB 3.2, up to 8x USB 2.0) up to 2x SATA up to 2x UART CAN (opt.) GPIOs SPI LPC SM Bus I2C						
Audio	HDA						
congatec Board controller	Multi Stage Watchdog non-volatile User Data Storage Manufacturing and Board Information Board Statistics I²C bus (fast mode, 400 kHz, multi-master) Power Loss Control Hardware Health Monitoring POST Code Redirection						
Embedded BIOS Feature	AMI Aptio® UEFI firmware 32 Mbyte serial SPI with congatec Embedded BIOS feature OEM Logo OEM CMOS default settings LCD Control Display Auto Detection Backlight Control Flash Update						
Security	Trusted Platform Module (TPM 2.0)						
Power Management	ACPI 6.0 with battery support						
Operating Systems	Microsoft® Windows 11 Microsoft® Windows 10 Microsoft® Windows 10 IoT Enterprise Linux Yocto Real Time Systems Hypervisor						
Temperature	Operating.: 0°C ... +60°C			Storage.: -20°C ... +70°C			
Humidity	Operating.: 10% ... 90% r. H. non cond.			Storage.: 5% ... 95% r. H. non cond.			
Size	95 x 95 mm						

conga-TC670 | Block Diagram



conga-TC670 | Order Information

Article	PN	Description
conga-TC670/i7-12800HE	049700	COM Express Type 6 Compact module based on Intel® Core™ i7-12800HE processor with 6 P-cores 2.4GHz up to 4.6GHz and 8 E-cores 1.8GHz up to 3.5GHz 24MB Intel® Smart Cache Intel® Iris® X ^e Graphics architecture with 96 EUs Dual channel DDR5 4800 MT/s memory interface Intel® code name Alder Lake-P (H-Series)
conga-TC670/i5-12600HE	049703	COM Express Type 6 Compact module based on Intel® Core™ i5-12600HE processor with 4 P-cores 2.5GHz up to 4.5GHz and 8 E-cores 1.8GHz up to 3.3GHz 18MB Intel® Smart Cache Intel® Iris® X ^e Graphics architecture with 80EUs Dual channel DDR5 4800 MT/s memory interface Intel® code name Alder Lake-P (H-Series)
conga-TC670/i3-12300HE	049706	COM Express Type 6 Compact module based on Intel® Core™ i3-12300HE processor with 4 P-cores 1.9GHz up to 4.3GHz and 4 E-cores 1.5GHz up to 3.3GHz 12MB Intel® Smart Cache Intel® UHD Graphics with 48EUs Dual channel DDR5 4800 MT/s memory interface Intel® code name Alder Lake-P (H-Series)

Mouser Electronics

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